

Document Title

256Kx16 bit Dynamic RAM with EDO Page Mode

Revision History

| Revision No | History | Draft Date | Remark |
|-------------|----------------------------|-----------------|--------|
| 0A | Initial Draft | August 9,2001 |)1 |
| 0B | Revise for typo on page 20 | December 18,200 | |

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IC41C16256 IC41LV16256



256K x 16 (4-MBIT) DYNAMIC RAM WITH EDO PAGE MODE

FEATURES

- Extended Data-Out (EDO) Page Mode access cycle
- TTL compatible inputs and outputs; tristate I/O
- Refresh Interval: 512 cycles /8 ms
- Refresh Mode: RAS-Only, CAS-before-RAS (CBR), Hidden
- Single power supply: 5V ± 10% (IC41C16256) 3.3V ± 10% (IC41LV16256)
- Byte Write and Byte Read operation via two CAS
- Industrail Temperature Range -40°C to 85°C

DESCRIPTION

The *ICSI* IC41C16256 and IC41LV16256 is a 262,144 x 16bit high-performance CMOS Dynamic Random Access Memories. The IC41C16256 offer an accelerated cycle access called EDO Page Mode. EDO Page Mode allows 512 random accesses within a single row with access cycle time as short as 10 ns per 16-bit word. The Byte Write control, of upper and lower byte, makes the IC41C16256 ideal for use in 16-, 32-bit wide data bus systems.

These features make the IC41C16256 and IC41LV16256 ideally suited for high-bandwidth graphics, digital signal processing, high-performance computing systems, and peripheral applications.

The IC41C16256 is packaged in a 40-pin 400mil SOJ and 400mil TSOP-2.

KEY TIMING PARAMETERS

| Parameter | -25(5V) | -35 | -50 | -60 | Unit |
|---------------------------------------|---------|-----|-----|-----|------|
| Max. RAS Access Time (tRAC) | 25 | 35 | 50 | 60 | ns |
| Max. CAS Access Time (tcac) | 8 | 10 | 14 | 15 | ns |
| Max. Column Address Access Time (tAA) | 12 | 18 | 25 | 30 | ns |
| Min. EDO Page Mode Cycle Time (tPc) | 10 | 12 | 20 | 25 | ns |
| Min. Read/Write Cycle Time (tRc) | 45 | 60 | 90 | 110 | ns |

PIN CONFIGURATIONS 40-Pin TSOP-2

| vcc 🗖 | 1 • | 40 🔲 GND |
|--------|-----|------------|
| I/O0 [| 2 | 39 🛄 I/O15 |
| I/O1 🔳 | 3 | 38 🔟 1/014 |
| I/O2 | 4 | 37 🔟 1/013 |
| I/O3 [| 5 | 36 🔲 1/012 |
| vcc 🗖 | 6 | 35 🔲 GND |
| I/O4 [| 7 | 34 🔲 1/011 |
| I/O5 🔲 | 8 | 33 🔲 1/010 |
| I/O6 [| 9 | 32 🔲 1/O9 |
| I/07 🔲 | 10 | 31 🔲 1/08 |
| | | |
| | | |
| NC [| 11 | 30 🔲 NC |
| NC [| 12 | 29 🔲 LCAS |
| WE [| 13 | 28 🔲 ŪCAS |
| RAS [| 14 | 27 🔲 ŌĒ |
| NC [| 15 | 26 🔲 A8 |
| A0 [| 16 | 25 🔲 A7 |
| A1 [| 17 | 24 🔲 A6 |
| A2 🔲 | 18 | 23 🔲 A5 |
| A3 [| 19 | 22 🗖 A4 |
| VCC 🗖 | 20 | 21 🗍 GND |
| | | |

40-Pin SOJ

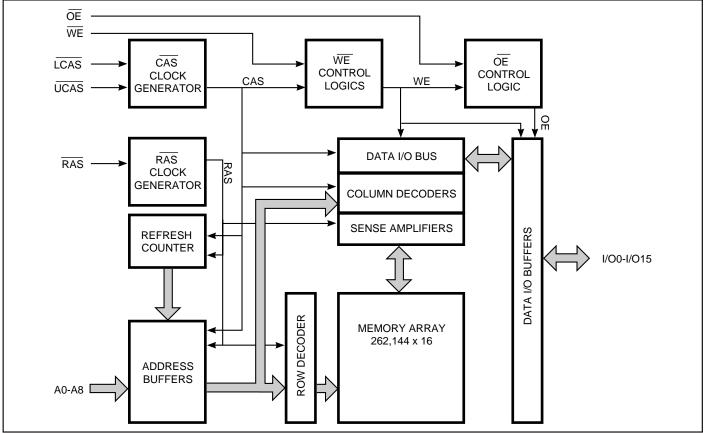
| | | ~ | _ | |
|--|--------|-------|------|-------|
| | VCC 🛛 | 1 • • | 40 | GND |
| | I/O0 [| 2 | 39 🛛 | I/O15 |
| | I/O1 [| 3 | 38 🛛 | I/O14 |
| | 1/02 🛛 | 4 | 37 🗋 | I/O13 |
| | I/O3 [| 5 | 36 🛛 | I/O12 |
| | | 6 | 35 🗌 | GND |
| | I/O4 [| 7 | 34 🛛 | I/O11 |
| | I/O5 [| 8 | 33 🗋 | I/O10 |
| | 1/06 🛛 | 9 | 32 🛛 | I/O9 |
| | 1/07 [| 10 | 31 | I/O8 |
| | NC 🛛 | 11 | 30 🛛 | NC |
| | NC 🛛 | 12 | 29 🗋 | LCAS |
| | WE [| 13 | 28 | UCAS |
| | RAS [| 14 | 27 | ŌĒ |
| | | 15 | 26 | A8 |
| | A0 [| 16 | 25 | A7 |
| | A1 [| 17 | 24 | A6 |
| | A2 [| 18 | 23 | A5 |
| | АЗ [| 19 | 22 | A4 |
| | | 20 | 21 | GND |
| | ' | | | |
| | | | | |

PIN DESCRIPTIONS

| A0-A8 | Address Inputs |
|---------|-----------------------------|
| I/O0-15 | Data Inputs/Outputs |
| WE | Write Enable |
| ŌĒ | Output Enable |
| RAS | Row Address Strobe |
| UCAS | Upper Column Address Strobe |
| LCAS | Lower Column Address Strobe |
| Vcc | Power |
| GND | Ground |
| NC | No Connection |



FUNCTIONAL BLOCK DIAGRAM





TRUTH TABLE

| Function | | RAS | LCAS | UCAS | WE | ŌĒ | Address tr/tc | I/O |
|------------------------------------|------------|-------------------|-------------------|-------------------|-----|-------------------|---------------|--|
| Standby | | Н | Н | Н | Х | Х | Х | High-Z |
| Read: Word | | L | L | L | Н | L | ROW/COL | Dout |
| Read: Lower Byte | | L | L | Н | Н | L | ROW/COL | Lower Byte, Dout Upper Byte, High-Z |
| Read: Upper Byte | | L | Н | L | Н | L | ROW/COL | Lower Byte, High-Z Upper Byte, Dout |
| Write: Word (Early Write) | | L | L | L | L | Х | ROW/COL | Din |
| Write: Lower Byte (Early \ | Vrite) | L | L | Н | L | Х | ROW/COL | Lower Byte, Dın Upper Byte, High-Z |
| Write: Upper Byte (Early V | Write) | L | Н | L | L | Х | ROW/COL | Lower Byte, High-Z Upper Byte, Dın |
| Read-Write ^(1,2) | | L | L | L | H→L | $L \rightarrow H$ | ROW/COL | Dout, Din |
| EDO Page-Mode Read ⁽²⁾ | 1st Cycle: | L | H→L | H→L | Н | L | ROW/COL | Dout |
| | 2nd Cycle: | L | H→L | H→L | Н | L | NA/COL | Dout |
| | Any Cycle: | L | L→H | L→H | Н | L | NA/NA | Dout |
| EDO Page-Mode Write ⁽¹⁾ | 1st Cycle: | L | $H \rightarrow L$ | $H \rightarrow L$ | L | Х | ROW/COL | Din |
| | 2nd Cycle: | L | H→L | H→L | L | Х | NA/COL | Din |
| EDO Page-Mode | 1st Cycle: | L | H→L | H→L | H→L | L→H | ROW/COL | Dout, Din |
| Read-Write ^(1,2) | 2nd Cycle: | L | H→L | H→L | H→L | L→H | NA/COL | Dout, Din |
| Hidden Refresh ⁽²⁾ | Read L | →H→L | L | L | Н | L | ROW/COL | Dout |
| | Write L | →H→L | L | L | L | Х | ROW/COL | Dout |
| RAS-Only Refresh | | L | Н | Н | Х | Х | ROW/NA | High-Z |
| CBR Refresh ⁽³⁾ | | $H \rightarrow L$ | L | L | Х | Х | Х | High-Z |

Notes:

These WRITE cycles may also be BYTE WRITE cycles (either LCAS or UCAS active).
 These READ cycles may also be BYTE READ cycles (either LCAS or UCAS active).

3. At least one of the two \overrightarrow{CAS} signals must be active (\overrightarrow{LCAS} or \overrightarrow{UCAS}).



Functional Description

The IC41C16256 and IC41LV16256 is a CMOS DRAM optimized for high-speed bandwidth, low power applications. During READ or WRITE cycles, each bit is uniquely addressed through the 18 address bits. These are entered 9 bits (A0-A8) at a time. <u>The</u> row address is latched by the Row Address Strobe (RAS). The column address is latched by the Column Address Strobe (CAS).

The IC41C16256 and IC41LV16256 has two CAS controls, ICAS and UCAS. The LCAS and UCAS inputs internally generates a CAS signal functioning in an identical manner to the single CAS input on the other 256K x 16 DRAMs. The key difference is that each CAS controls its corresponding I/O tristate logic (in conjunction with OE and WE and RAS). LCAS controls I/O0 through I/O7 and UCAS controls I/O8 through I/O15.

The IC41C16256 and IC41LV16256 CAS function is determined by the first CAS (LCAS or UCAS) transitioning LOW and the last transitioning back HIGH. The two CAS controls give the IC41C16256 both BYTE READ and BYTE WRITE cycle capabilities.

Memory Cycle

A memory cycle is initiated by bring \overrightarrow{RAS} LOW and it is terminated by returning both \overrightarrow{RAS} and \overrightarrow{CAS} HIGH. To ensures proper device operation and data integrity any memory cycle, once initiated, must not be ended or aborted before the minimum tRAS time has expired. A new cycle must not be initiated until the minimum precharge time tRP, tcP has elapsed.

Read Cycle

A read cycle is initiated by the falling edge of \overline{CAS} or \overline{OE} , whichever occurs last, while holding WE HIGH. The column address must be held for a minimum time specified by tar. Data Out becomes valid only when trac, taa, tcac and toe are all satisfied. As a result, the access time is dependent on the timing relationships between these parameters.

Write Cycle

<u>A write cycle is initiated by the falling edge of \overline{CAS} and WE, whichever occurs last. The input data must be valid at or before the falling edge of \overline{CAS} or \overline{WE} , whichever occurs first.</u>

Refresh Cycle

To retain data, 512 refresh cycles are required in each 8 ms period. There are two ways to refresh the memory.

- 1. By clocking each of the 512 row addresses (A0 through A8) with RAS at least once every 8 ms. Any read, write, read-modify-write or RAS-only cycle refreshes the addressed row.
- 2. Using a CAS-before-RAS refresh cycle. CAS-before-RAS refresh is activated by the falling edge of RAS, while holding CAS LOW. In CAS-before-RAS refresh cycle, an internal 9-bit counter provides the row addresses and the external address inputs are ignored.

CAS-before-RAS is a refresh-only mode and no data access or device selection is allowed. Thus, the output remains in the High-Z state during the cycle.

Extended Data Out Page Mode

EDO page mode operation permits all 512 columns within a selected row to be randomly accessed at a high data rate.

In EDO page mode read cycle, the data-out is held to the next CAS cycle's falling edge, instead of the rising edge. For this reason, the valid data output time in EDO page mode is extended compared with the fast page mode. In the fast page mode, the valid data output time becomes shorter as the CAS cycle time becomes shorter. Therefore, in EDO page mode, the timing margin in read cycle is larger than that of the fast page mode even if the CAS cycle time becomes shorter.

In EDO page mode, due to the extended data function, the CAS cycle time can be shorter than in the fast page mode if the timing margin is the same.

The EDO page mode allows both read and write operations during one RAS cycle, but the performance is equivalent to that of the fast page mode in that case.

Power-On

After application of the Vcc supply, an initial pause of 200 µs is required followed by a minimum of eight initialization cycles (any combination of cycles containing a RAS signal).

During power-on, it is recommended that \overline{RAS} track with Vcc or be held at a valid VIH to avoid current surges.



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

| Symbol | Parameters | | Rating | Unit |
|--------|------------------------------------|------|--------------|------|
| Vт | Voltage on Any Pin Relative to GND | 5V | -1.0 to +7.0 | V |
| | | 3.3V | -0.5 to +4.6 | |
| Vcc | Supply Voltage | 5V | -1.0 to +7.0 | V |
| | | 3.3V | –0.5 to +4.6 | |
| Ιουτ | Output Current | | 50 | mA |
| Pd | Power Dissipation | | 1 | W |
| TA | Commercial Operation Temperature | | 0 to +70 | °C |
| | Industrial Operationg Temperature | | -40 to +85 | °C |
| Tstg | Storage Temperature | | -55 to +125 | °C |

Note:

1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

RECOMMENDED OPERATING CONDITIONS (Voltages are referenced to GND.)

| Symbol | Parameter | | Min. | Тур. | Max. | Unit |
|--------|--------------------------------|------|------|------|-----------|------|
| Vcc | Supply Voltage | 5V | 4.5 | 5.0 | 5.5 | V |
| | | 3.3V | 3.0 | 3.3 | 3.6 | |
| Vін | Input High Voltage | 5V | 2.4 | _ | Vcc + 1.0 | V |
| | | 3.3V | 2.0 | | Vcc + 0.3 | |
| VIL | Input Low Voltage | 5V | -1.0 | _ | 0.8 | V |
| | | 3.3V | -0.3 | | 0.8 | |
| TA | Commercial Ambient Temperature | | 0 | _ | 70 | °C |
| | Industrial Ambient Temperature | | -40 | | 85 | °C |

CAPACITANCE^(1,2)

| Symbol | Parameter | Max. | Unit |
|--------|--|------|------|
| CIN1 | Input Capacitance: A0-A8 | 5 | pF |
| CIN2 | Input Capacitance: RAS, UCAS, LCAS, WE, OE | 7 | pF |
| Сю | Data Input/Output Capacitance: I/O0-I/O15 | 7 | pF |

Notes:

1. Tested initially and after any design or process changes that may affect these parameters.

2. Test conditions: $T_A = 25^{\circ}C$, f = 1 MHz.



ELECTRICAL CHARACTERISTICS⁽¹⁾

(Recommended Operating Conditions unless otherwise noted.)

| Symbol | Parameter | Test Condition | Speed | Min. | Max. | Unit |
|--------|--|---|--------------------------|------|--------------------------|------|
| lıl | Input Leakage Current | Any input 0V < V _{IN} < Vcc Other inputs not under test = 0V | | -10 | 10 | μA |
| lio | Output Leakage Current | Output is disabled (Hi-Z) 0V < Vout < Vcc | | -10 | 10 | μA |
| Vон | Output High Voltage Level | Іон = –2.5 mA | | 2.4 | | V |
| Vol | Output Low Voltage Level | loL =+2.1mA | | _ | 0.4 | V |
| Icc1 | Standby Current: TTL | RAS, LCAS, UCAS > VIH Commerica Industrial Commerica Industrial | 5V | | 2 3 1 2 | mA |
| Icc2 | Standby Current: CMOS | $\overline{\text{RAS}}$, $\overline{\text{LCAS}}$, $\overline{\text{UCAS}}$ > Vcc - 0.2V | 5V 3.3V | _ | 1 0.5 | mA |
| Іссз | Operating Current: Random Read/Write ^(2,3,4) Average Power Supply Current | \overline{RAS} , \overline{LCAS} , \overline{UCAS} , Address Cycling, trc = trc (min.) | -25 -35 -50 -60 | | 260 230 180 170 | mA |
| Icc4 | Operating Current: EDO Page Mode ^(2,3,4) Average Power Supply Current | $\overline{RAS} = VIL, \overline{LCAS}, \overline{UCAS},$ Cycling tPc = tPc (min.) | -25 -35 -50 -60 | | 250 220 170 160 | mA |
| ICC5 | Refresh Current: RAS-Only ^(2,3) Average Power Supply Current | $\overline{\text{RAS}} \text{ Cycling, } \overline{\text{LCAS}}, \overline{\text{UCAS}} > \text{ViH}$ trc = trc (min.) | -25 -35 -50 -60 | | 260 230 180 170 | mA |
| Icc6 | Refresh Current: CBR ^(2,3,5) Average Power Supply Current | $\overline{RAS}, \overline{LCAS}, \overline{UCAS} Cycling$ $t_{RC} = t_{RC} (min.)$ | -25 -35 -50 -60 | | 260 230 180 170 | mA |

Notes:

1. An initial pause of 200 µs is required after power-up followed by eight RAS refresh cycles (RAS-Only or CBR) before proper device operation is assured. The eight RAS cycles wake-up should be repeated any time the tREF refresh requirement is exceeded.

2. Dependent on cycle rates.

3. Specified values are obtained with minimum cycle time and the output open.

4. Column-address is changed once each EDO page cycle.

5. Enables on-chip refresh and address counters.



AC CHARACTERISTICS^(1,2,3,4,5,6)

(Recommended Operating Conditions unless otherwise noted.)

| | | | 25 | -; | 35 | | 50 | -60 | | | |
|--------------|---|------|------|------|------|------|------|------|------|-------|--|
| Symbol | Parameter | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | Units | |
| trc | Random READ or WRITE Cycle Time | 45 | _ | 60 | | 90 | _ | 110 | | ns | |
| t RAC | Access Time from RAS ^(6, 7) | _ | 25 | | 35 | | 50 | | 60 | ns | |
| tcac | Access Time from CAS ^(6, 8, 15) | _ | 8 | _ | 10 | | 14 | _ | 15 | ns | |
| taa | Access Time from Column-Address ⁽⁶⁾ | _ | 12 | _ | 18 | | 25 | _ | 30 | ns | |
| tras | RAS Pulse Width | 25 | 10K | 35 | 10K | 50 | 10K | 60 | 10K | ns | |
| t RP | RAS Precharge Time | 15 | _ | 20 | | 30 | | 40 | | ns | |
| tcas | CAS Pulse Width ⁽²⁶⁾ | 4 | 10K | 6 | 10K | 8 | 10K | 10 | 10K | ns | |
| tcp | CAS Precharge Time ^(9, 25) | 4 | _ | 5 | | 8 | | 10 | | ns | |
| tcsн | CAS Hold Time (21) | 25 | _ | 35 | | 50 | | 60 | | ns | |
| trcd | RAS to CAS Delay Time ^(10, 20) | 10 | 17 | 11 | 28 | 19 | 36 | 20 | 45 | ns | |
| tasr | Row-Address Setup Time | 0 | _ | 0 | | 0 | _ | 0 | | ns | |
| traн | Row-Address Hold Time | 6 | _ | 6 | _ | 8 | _ | 10 | | ns | |
| tasc | Column-Address Setup Time ⁽²⁰⁾ | 0 | _ | 0 | | 0 | | 0 | | ns | |
| tсан | Column-Address Hold Time ⁽²⁰⁾ | 5 | _ | 6 | | 8 | | 10 | | ns | |
| t ar | Column-Address Hold Time (referenced to RAS) | 19 | — | 30 | — | 40 | — | 40 | — | ns | |
| t RAD | RAS to Column-Address Delay Time ⁽¹¹⁾ | 8 | 20 | 10 | 20 | 14 | 25 | 15 | 30 | ns | |
| t RAL | Column-Address to RAS Lead Time | 12 | _ | 18 | | 25 | _ | 30 | | ns | |
| t RPC | RAS to CAS Precharge Time | 0 | _ | 0 | _ | 0 | _ | 0 | | ns | |
| trsн | RAS Hold Time ⁽²⁷⁾ | 7 | _ | 8 | | 14 | _ | 15 | | ns | |
| tc∟z | CAS to Output in Low-Z ^(15, 29) | 3 | _ | 3 | _ | 3 | | 3 | | ns | |
| tCRP | CAS to RAS Precharge Time ⁽²¹⁾ | 5 | _ | 5 | _ | 5 | _ | 5 | | ns | |
| top | Output Disable Time ^(19, 28, 29) | 2 | 12 | 3 | 12 | 3 | 12 | 3 | 12 | ns | |
| toe | Output Enable Time ^(15, 16) | 0 | 8 | 0 | 10 | 0 | 15 | | 15 | ns | |
| tоенс | OE HIGH Hold Time from CAS HIGH | 10 | _ | 10 | _ | 10 | | 10 | | ns | |
| toep | OE HIGH Pulse Width | 10 | _ | 10 | | 10 | _ | 10 | _ | ns | |
| toes | OE LOW to CAS HIGH Setup Time | 5 | _ | 5 | _ | 5 | | 5 | _ | ns | |
| trcs | Read Command Setup Time ^(17, 20) | 0 | _ | 0 | _ | 0 | | 0 | | ns | |
| t RRH | Read Command Hold Time (referenced to RAS) ⁽¹²⁾ | 0 | — | 0 | — | 0 | — | 0 | — | ns | |
| trcн | Read Command Hold Time (referenced to CAS) ^(12, 17, 21) | 0 | — | 0 | — | 0 | — | 0 | — | ns | |
| twcн | Write Command Hold Time ^(17, 27) | 5 | _ | 5 | | 8 | _ | 10 | _ | ns | |
| twcr | Write Command Hold Time (referenced to RAS) ⁽¹⁷⁾ | 19 | _ | 30 | _ | 40 | _ | 50 | | ns | |
| twp | Write Command Pulse Width ⁽¹⁷⁾ | 5 | _ | 5 | | 8 | _ | 10 | _ | ns | |
| twpz | WE Pulse Widths to Disable Outputs | 10 | _ | 10 | | 10 | _ | 10 | _ | ns | |
| trwl | Write Command to RAS Lead Time ⁽¹⁷⁾ | 7 | _ | 8 | _ | 14 | _ | 15 | | ns | |
| tcwL | Write Command to CAS Lead Time ^(17, 21) | 5 | _ | 8 | | 14 | _ | 15 | | ns | |
| twcs | Write Command Setup Time ^(14, 17, 20) | 0 | _ | 0 | _ | 0 | _ | 0 | | ns | |
| tdhr | Data-in Hold Time (referenced to \overline{RAS}) | 19 | | 30 | | 40 | | 40 | | ns | |



AC CHARACTERISTICS (Continued)(1,2,3,4,5,6)

(Recommended Operating Conditions unless otherwise noted.)

| | | | 25 | -: | 35 | | 50 | -(| 60 | |
|---------------|--|------|------|------|------|------|------|------|------|-------|
| Symbol | Parameter | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | Units |
| tасн | Column-Address Setup Time to CAS Precharge during WRITE Cycle | 15 | — | 15 | — | 15 | — | 15 | — | ns |
| tоен | OE Hold Time from WE during READ-MODIFY-WRITE cycle ⁽¹⁸⁾ | 5 | — | 8 | — | 10 | _ | 15 | _ | ns |
| tos | Data-In Setup Time ^(15, 22) | 0 | | 0 | _ | 0 | _ | 0 | _ | ns |
| tdн | Data-In Hold Time ^(15, 22) | 5 | | 6 | _ | 8 | | 10 | _ | ns |
| trwc | READ-MODIFY-WRITE Cycle Time | 65 | | 80 | | 125 | | 140 | _ | ns |
| trwd | RAS to WE Delay Time during READ-MODIFY-WRITE Cycle ⁽¹⁴⁾ | 35 | _ | 45 | _ | 70 | _ | 80 | _ | ns |
| tcwD | CAS to WE Delay Time ^(14, 20) | 17 | | 25 | | 34 | | 36 | _ | ns |
| tawd | Column-Address to WE Delay Time ⁽¹⁴⁾ | 21 | | 30 | _ | 42 | | 49 | _ | ns |
| tPC | EDO Page Mode READ or WRITE Cycle Time ⁽²⁴⁾ | 10 | — | 12 | — | 20 | | 25 | _ | ns |
| t RASP | RAS Pulse Width in EDO Page Mode | 25 | 100K | 35 | 100K | 50 | 100K | 50 | 100K | ns |
| t CPA | Access Time from CAS Precharge ⁽¹⁵⁾ | | 14 | _ | 21 | _ | 27 | | 34 | ns |
| t PRWC | EDO Page Mode READ-WRITE Cycle Time ⁽²⁴⁾ | 32 | — | 40 | — | 47 | | 56 | _ | ns |
| tсон | Data Output Hold after CAS LOW | 5 | | 5 | | 5 | | 5 | _ | ns |
| toff | Output Buffer Turn-Off Delay from CAS or RAS ^(13,15,19, 29) | 3 | 15 | 3 | 15 | 3 | 15 | 3 | 15 | ns |
| twнz | Output Disable Delay from WE | 3 | 15 | 3 | 15 | 3 | 15 | 3 | 15 | ns |
| tclch | Last CAS going LOW to First CAS returning HIGH ⁽²³⁾ | 10 | _ | 10 | _ | 10 | _ | 10 | _ | ns |
| tCSR | CAS Setup Time (CBR REFRESH) ^(30, 20) | 5 | | 8 | | 10 | | 10 | _ | ns |
| t CHR | CAS Hold Time (CBR REFRESH) ^(30, 21) | 7 | | 8 | | 10 | | 10 | | ns |
| tord | OE Setup Time prior to RAS during HIDDEN REFRESH Cycle | 0 | — | 0 | — | 0 | — | 0 | — | ns |
| t REF | Refresh Period (512 Cycles) | _ | 8 | _ | 8 | 8 | | 8 | _ | ms |
| t⊤ | Transition Time (Rise or Fall) ^(2, 3) | 1 | 50 | 1 | 50 | 1 | 50 | 1 | 50 | ns |

AC TEST CONDITIONS

Output load:

Two TTL Loads and 50 pF (Vcc = $5.0V \pm 10\%$) One TTL Load and 50 pF (Vcc = $3.3V \pm 10\%$)

Input timing reference levels: $V_{IH} = 2.4V$, $V_{IL} = 0.8V$ (Vcc = 5.0V ±10%); $V_{IH} = 2.0V$, $V_{IL} = 0.8V$ (Vcc = 3.3V ±10%)

Output timing reference levels: VOH = 2.0V, VOL = 0.8V ($Vcc = 5V \pm 10\%$, $3.3V \pm 10\%$)

IC41C16256 IC41LV16256



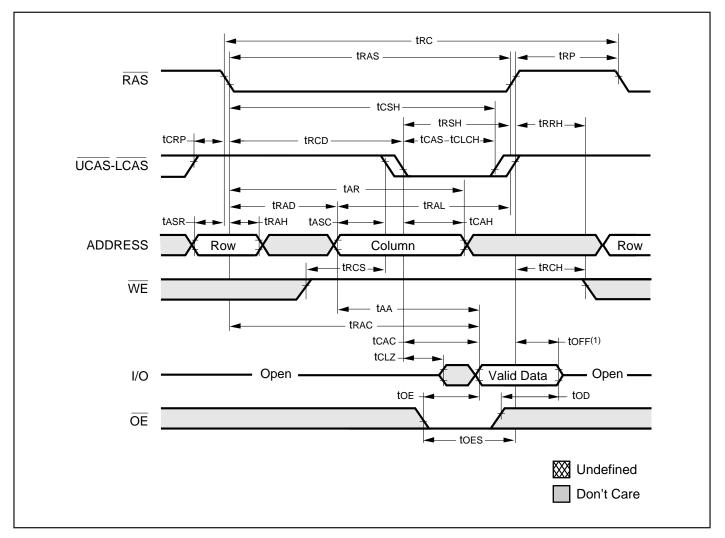
Notes:

- 1. An initial pause of 200 μs is required after power-up followed by eight RAS refresh cycle (RAS-Only or CBR) before proper device operation is assured. The eight RAS cycles wake-up should be repeated any time the tREF refresh requirement is exceeded.
- 2. VIH (MIN) and VIL (MAX) are reference levels for measuring timing of input signals. Transition times, are measured between VIH and VIL (or between VIL and VIH) and assume to be 1 ns for all inputs.
- 3. In addition to meeting the transition rate specification, all input signals must transit between V_{IH} and V_{IL} (or between V_{IL} and V_{IH}) in a monotonic manner.
- 4. If \overline{CAS} and $\overline{RAS} = V_{H}$, data output is High-Z.
- 5. If $\overline{CAS} = V_{IL}$, data output may contain data from the last valid READ cycle.
- 6. Measured with a load equivalent to one TTL gate and 50 pF.
- 7. Assumes that tRCD ≤ tRCD (MAX). If tRCD is greater than the maximum recommended value shown in this table, tRAC will increase by the amount that tRCD exceeds the value shown.
- 8. Assumes that $tRCD \ge tRCD$ (MAX).
- 9. If CAS is LOW at the falling edge of RAS, data out will be maintained from the previous cycle. To initiate a new cycle and clear the data output buffer, CAS and RAS must be pulsed for tcp.
- 10. Operation with the tRCD (MAX) limit ensures that tRAC (MAX) can be met. tRCD (MAX) is specified as a reference point only; if tRCD is greater than the specified tRCD (MAX) limit, access time is controlled exclusively by tCAC.
- 11. Operation within the tRAD (MAX) limit ensures that tRCD (MAX) can be met. tRAD (MAX) is specified as a reference point only; if tRAD is greater than the specified tRAD (MAX) limit, access time is controlled exclusively by tAA.
- 12. Either tRCH or tRRH must be satisfied for a READ cycle.
- 13. toFF (MAX) defines the time at which the output achieves the open circuit condition; it is not a reference to VOH or VOL.
- 14. twcs, trwb, tawb and tcwb are restrictive operating parameters in LATE WRITE and READ-MODIFY-WRITE cycle only. If twcs ≥ twcs (MIN), the cycle is an EARLY WRITE cycle and the data output will remain open circuit throughout the entire cycle. If trwb ≥ trwb (MIN), tawb ≥ tawb (MIN) and tcwb ≥ tcwb (MIN), the cycle is a READ-WRITE cycle and the data output will contain data read from the selected cell. If neither of the above conditions is met, the state of I/O (at access time and until CAS and RAS or OE go back to VIH) is indeterminate. OE held HIGH and WE taken LOW after CAS goes LOW result in a LATE WRITE (OE-controlled) cycle.
- 15. Output parameter (I/O) is referenced to corresponding \overline{CAS} input, I/O0-I/O7 by \overline{LCAS} and I/O8-I/O15 by \overline{UCAS} .
- 16. During a READ cycle, if \overline{OE} is LOW then taken HIGH before \overline{CAS} goes HIGH, I/O goes open. If \overline{OE} is tied permanently LOW, a LATE WRITE or READ-MODIFY-WRITE is not possible.
- 17. Write command is defined as $\overline{\text{WE}}$ going low.
- 18. LATE WRITE and READ-MODIFY-WRITE cycles must have both top and toeH met (OE HIGH during WRITE cycle) in order to ensure that the output buffers will be open during the WRITE cycle. The I/Os will provide the previously written data if CAS remains LOW and OE is taken back to LOW after toeH is met.
- 19. The I/Os are in open during READ cycles once top or toFF occur.
- 20. The first $\chi \overline{CAS}$ edge to transition LOW.
- 21. The last $\chi \overline{CAS}$ edge to transition HIGH.
- 22. These parameters are referenced to CAS leading edge in EARLY WRITE cycles and WE leading edge in LATE WRITE or READ-MODIFY-WRITE cycles.
- 23. Last falling $\chi \overline{CAS}$ edge to first rising $\chi \overline{CAS}$ edge.
- 24. Last rising $\chi \overline{CAS}$ edge to next cycle's last rising $\chi \overline{CAS}$ edge.
- 25. Last rising $\chi \overline{CAS}$ edge to first falling $\chi \overline{CAS}$ edge.
- 26. Each χ CAS must meet minimum pulse width.
- 27. Last $\chi \overline{CAS}$ to go LOW.
- 28. I/Os controlled, regardless UCAS and LCAS.
- 29. The 3 ns minimum is a parameter guaranteed by design.
- 30. Enables on-chip refresh and address counters.

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READ CYCLE

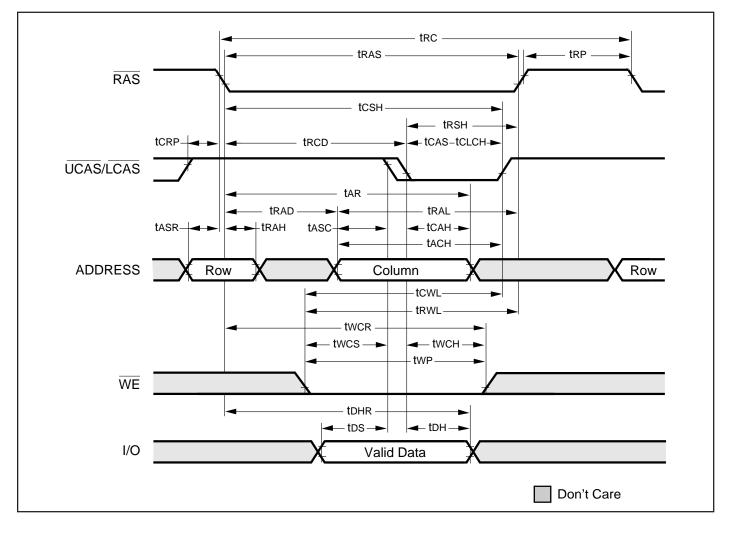


Note:

1. toff is referenced from rising edge of \overline{RAS} or \overline{CAS} , whichever occurs last.

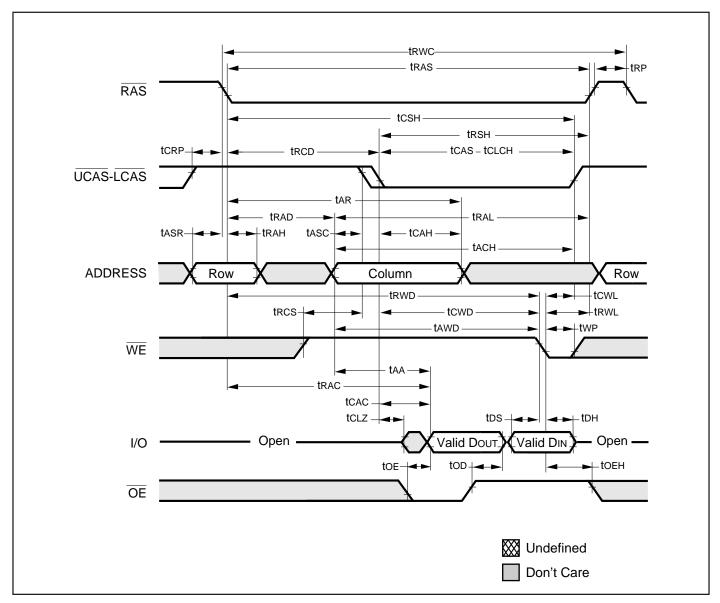


EARLY WRITE CYCLE (OE = DON'T CARE)



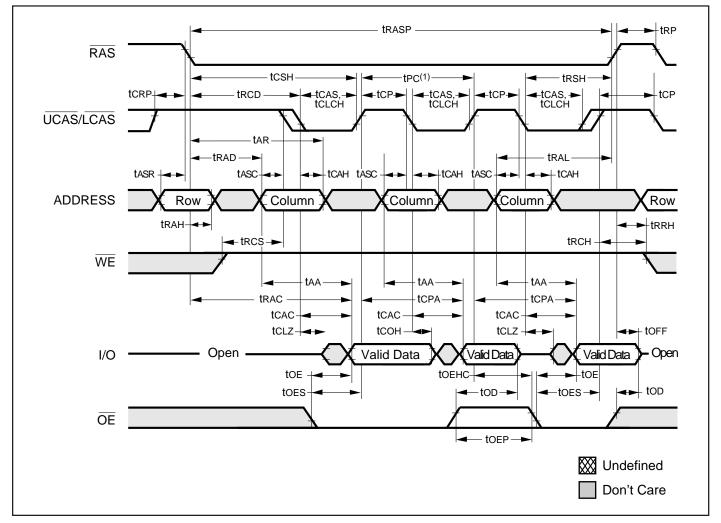


READ WRITE CYCLE (LATE WRITE and READ-MODIFY-WRITE Cycles)





EDO-PAGE-MODE READ CYCLE



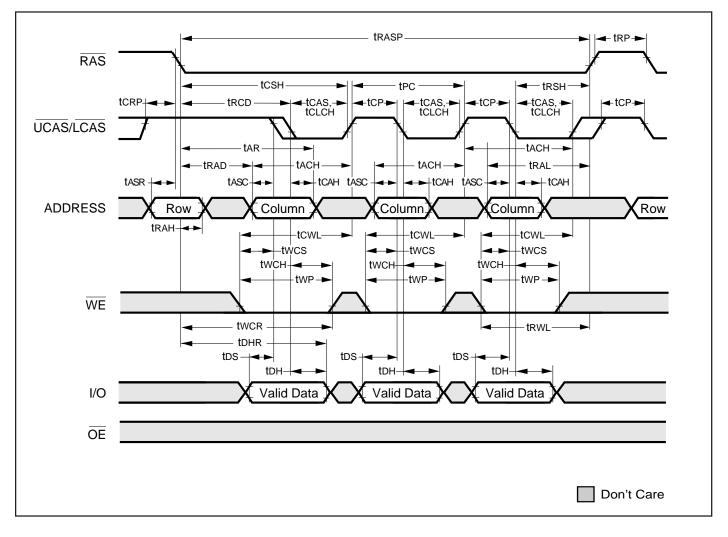
Note:

1. tPc can be measured from falling edge of CAS to falling edge of CAS, or from rising edge of CAS to rising edge of CAS. Both measurements must meet the tPc specifications.

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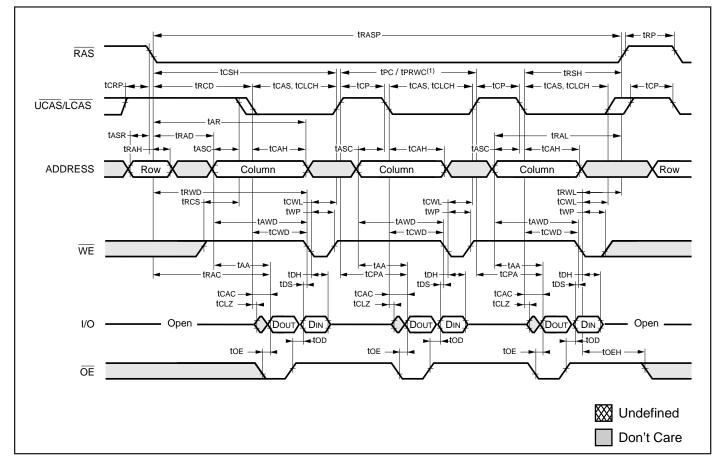


EDO-PAGE-MODE EARLY-WRITE CYCLE





EDO-PAGE-MODE READ-WRITE CYCLE (LATE WRITE and READ-MODIFY WRITE Cycles)

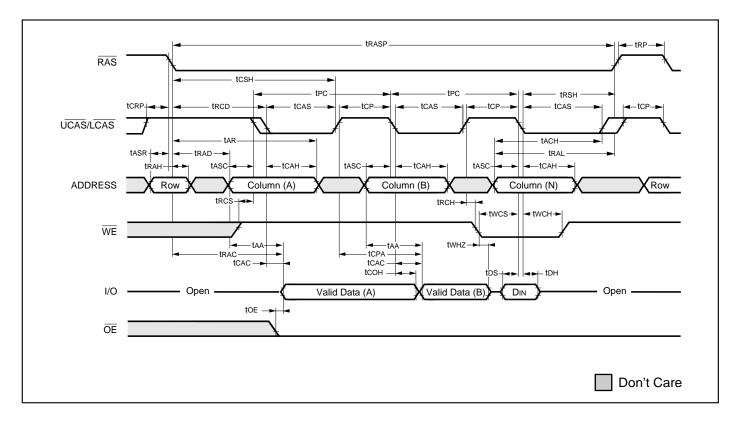


Note:

1. <u>tPc</u> is for LATE write cycles only. tPc can be measured from falling edge of CAS to falling edge of CAS, or from rising edge of CAS. Both measurements must meet the tPc specifications.

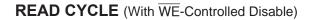


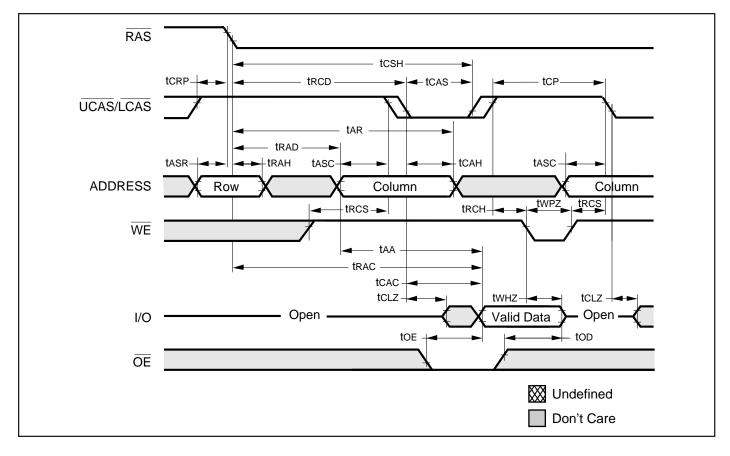
EDO-PAGE-MODE READ-EARLY-WRITE CYCLE (Psuedo READ-MODIFY WRITE)



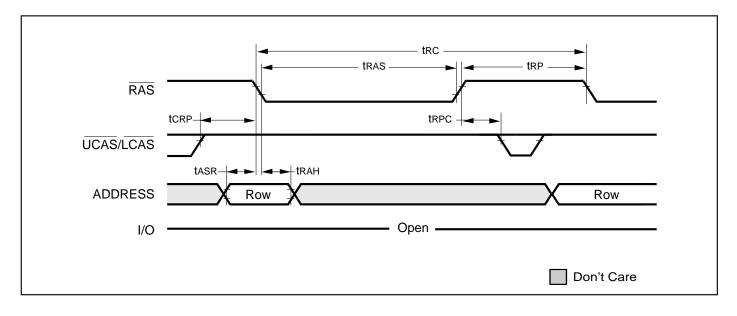


AC WAVEFORMS



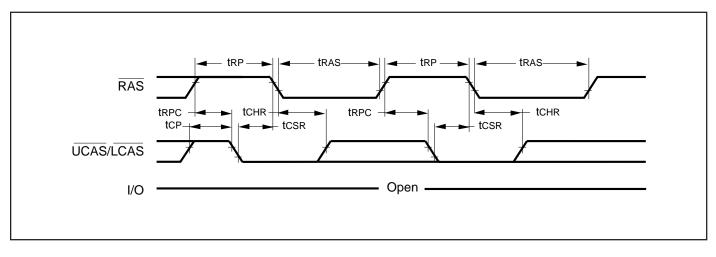


RAS-ONLY REFRESH CYCLE (OE, WE = DON'T CARE)

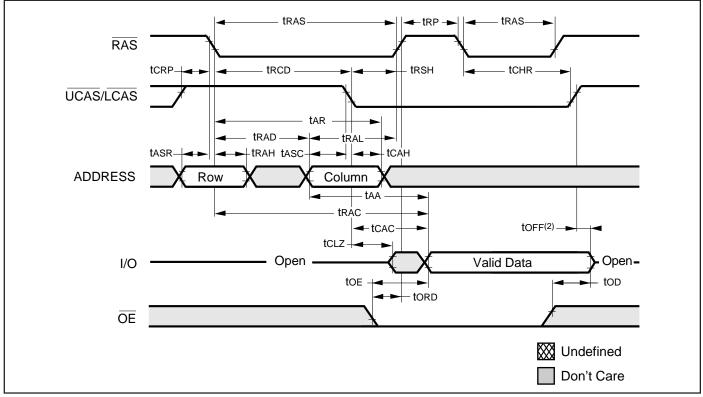




CBR REFRESH CYCLE (Addresses; \overline{WE} , \overline{OE} = DON'T CARE)



HIDDEN REFRESH CYCLE⁽¹⁾ (\overline{WE} = HIGH; \overline{OE} = LOW)



Notes:

1. A Hidden Refresh may also be performed after a Write Cycle. In this case, $\overline{WE} = LOW$ and $\overline{OE} = HIGH$. 2. toFF is referenced from rising edge of RAS or CAS, whichever occurs last.

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ORDERING INFORMATION

IC41C16256

Commercial Range: 0°C to 70°C

| Speed (ns) | Order Part No. | Package |
|------------|----------------------------------|-----------------------------|
| 25 | IC41C16256-25K IC41C16256-25T | 400mil SOJ 400mil TSOP-2 |
| 35 | IC41C16256-35K IC41C16256-35T | 400mil SOJ 400mil TSOP-2 |
| 50 | IC41C16256-50K IC41C16256-50T | 400mil SOJ 400mil TSOP-2 |
| 60 | IC41C16256-60K IC41C16256-60T | 400mil SOJ 400mil TSOP-2 |

ORDERING INFORMATION: IC41LV16256

Commercial Range: 0°C to 70°C

| Speed (ns) Order Part No. | | Package | |
|---------------------------|-----------------|---------------|--|
| 35 | IC41LV16256-35K | 400mil SOJ | |
| | IC41LV16256-35T | 400mil TSOP-2 | |
| 50 | IC41LV16256-50K | 400mil SOJ | |
| | IC41LV16256-50T | 400mil TSOP-2 | |
| 60 | IC41LV16256-60K | 400mil SOJ | |
| | IC41LV16256-60T | 400mil TSOP-2 | |

Industrial Range: -40°C to 85°C

Industrial Range: -40°C to 85°C

| Speed (ns) | Order Part No. | Package | Speed (ns) | Order Part No. | Package |
|------------|------------------------------------|-----------------------------|------------|--------------------------------------|-----------------------------|
| 25 | IC41C16256-25KI IC41C16256-25TI | 400mil SOJ 400mil TSOP-2 | 35 | IC41LV16256-35K IC41LV16256-35T | 400mil SOJ 400mil TSOP-2 |
| 35 | IC41C16256-35KI IC41C16256-35TI | 400mil SOJ 400mil TSOP-2 | 50 | IC41LV16256-50KI IC41LV16256-50TI | 400mil SOJ 400mil TSOP-2 |
| 50 | IC41C16256-50KI IC41C16256-50TI | 400mil SOJ 400mil TSOP-2 | 60 | IC41LV16256-60KI IC41LV16256-60TI | 400mil SOJ 400mil TSOP-2 |
| 60 | IC41C16256-60KI IC41C16256-60TI | 400mil SOJ 400mil TSOP-2 | | | |





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